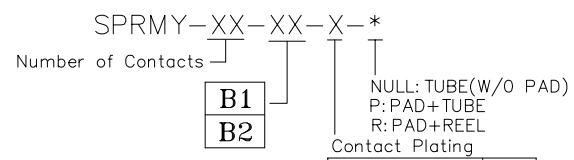
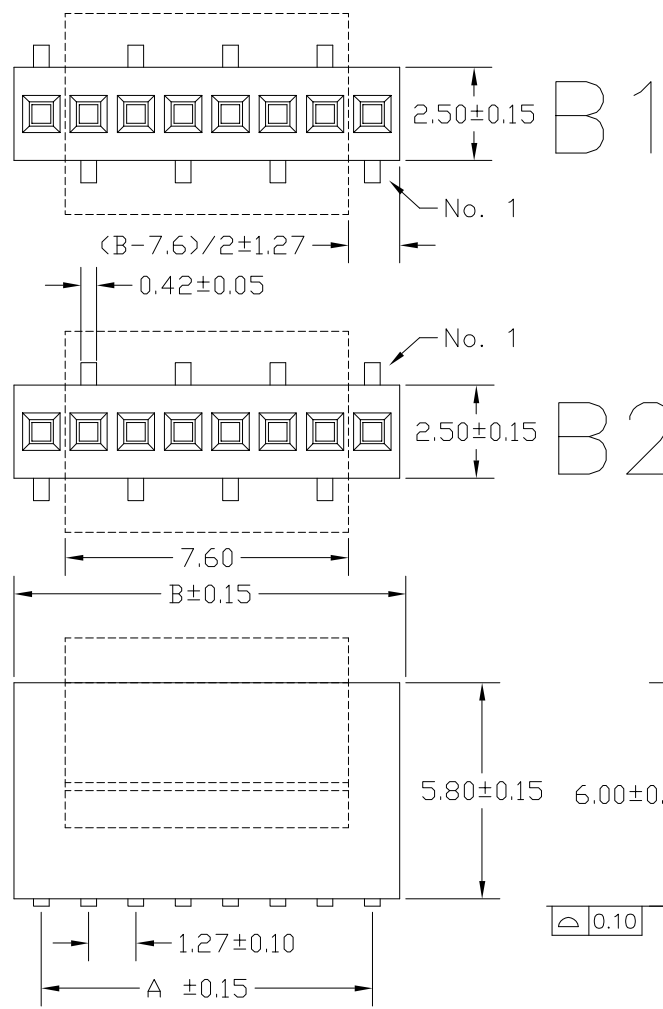


No. of Contacts	DIMENSIONS		No. of Contacts	DIMENSIONS		REMARK (備註)
	A	B		A	B	
3	2.54	4.01	27	33.02	34.49	○
4	3.81	5.28	28	34.29	35.76	○
5	5.08	6.55	29	35.56	37.03	○
6	6.35	7.82	30	36.83	38.30	○
7	7.62	9.09	31	38.10	39.57	○
8	8.89	10.36	32	39.37	40.84	○
9	10.16	11.63	33	40.64	42.11	○
10	11.43	12.90	34	41.91	43.38	○
11	12.70	14.17	35	43.18	44.65	○
12	13.97	15.44	36	44.45	45.92	○
13	15.24	16.71	37	45.72	47.19	○
14	16.51	17.98	38	46.99	48.46	○
15	17.78	19.25	39	48.26	49.73	○
16	19.05	20.52	40	49.53	51.00	○
17	20.32	21.79	41	50.80	52.27	○
18	21.59	23.06	42	52.07	53.54	○
19	22.86	24.33	43	53.34	54.81	○
20	24.13	25.60	44	54.61	56.08	○
21	25.40	26.87	45	55.88	57.35	○
22	26.67	28.14	46	57.15	58.62	○
23	27.94	29.41	47	58.42	59.92	○
24	29.21	30.68	48	59.69	61.16	○
25	30.48	31.95	49	60.96	62.43	○
26	31.75	33.22	50	62.23	63.70	○

**SPECIFICATIONS**

Current Rating: 1 Amp  
 Insulator resistance: 5000 Megohms min.  
 Contact resistance: 20 m ohm Max.  
 Dielectric withstanding: AC 500 V  
 Operating Temperature: -40° - +105°C  
 Contact Material: Phosphor Bronze.  
 Insulator Material: High Temperature Thermoplastic, UL 94V-0  
 Color : Black



Definition	Code
◎ Gold plated:	
flash B	15μ" F
10μ" E	30μ" J
◎ Duplex plating:	
flash K	15μ" P
10μ" N	30μ" U
◎ Standard: B	
◎ Prefix "V" means lead free plating.	

Recommended PCB Layout (PCB TOLERANCE ±0.05)

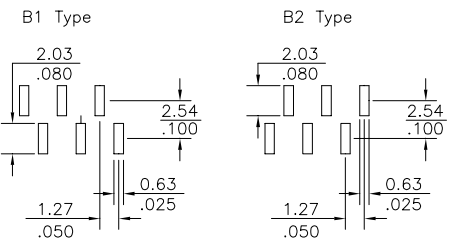


Diagram	Molding description	Rev.	ECN Number	Description	Drawn	Date
○	mass production & assemble mold	3	EC2-490393	圖面新增環保電鍍碼	邱若婷	09/22 04'
◎	sample & assemble mold	4	EC2-490635	圖面新增 PAD	陳美竹	10/05 04'
⊕	mass production & fix mold	5	EC2-570080	修改規格說明	詹益東	07/14/05'
⊗	sample & fix mold					



GENERAL TOLERANCE		SCALE	ORIGINAL DRAWN	DATE	DWG. NO.	TITLE	REV.
XX. ± 0.50	XXX. ±	?=1	邱若婷	09/22 04'	X-XX	1.27mm SMD SOCKET (成品規格圖)	5
X. ± 0.30	.XXX ±	UNIT	林錫錦	07/14/05'	F:\DWG\CDWG\SPRM\SPRMYOF.DWG		
.X ± 0.25	.X* ± 4*	SIZE	林錫錦	07/14/05'	PARTS NO.		SHEET
.XX ± 0.20	.X* ± 4*	A4			SPRMY-XX-XX-X-*		1/1